

NRZ
28
G b p s

(0.80 mm) .0315" PITCH • QTE/QSE SERIES

QTE Board Mates: OSF

QSE Board Mates:

QTE/QSE

Cable Mates: EQCD, EQDP

Standoffs: SO

SPECIFICATIONS

Insulator Material:
Liquid Crystal Polymer
Contact Material:
Phosphor Bronze
Plating:
Au or Sn over
50 μ" (1.27 μm) Ni
Current Rating:
Contact:
2 A per pin (2 pins powered)
Ground Plane:
23 A per ground plane
(1 ground plane powered)
Operating Temp Range:
-55 °C to +125 °C
Voltage Rating:
225 VAC when mated
& 5 mm Stack Height
Max Cycles:

QTE -	PINS PER ROV NO. OF PAIRS
	-020, -040 -060
	(40 total pins pe

-014, -028, -042 (14 pairs per bank = -D-DP)

Specify LEAD = Gold flash on contact, Matte Tin on tail Chart LI

LEAD

STYLE

= 10 µ" (0.25 µm) Gold on contact, Matte Tin on tail

PLATING

OPTION

-C = 50 µ" (1.27 mm) Electro-Polished Selective Gold on contact, Matte Tin on tail (passes 10 year MFG testing)

-D

Ended

-D-DP

= Differential
Pair
(-01 only)

= Single-

TYPE

film Pick & Place Pad

-L

= Latching Option (N/A on -042 & -060

positions)

OTHER

OPTIONS

-K

= (7.00 mm) .275" DIA Polyimide **-TR** =Tape & Reel (N/A -05 to -07 lead style)

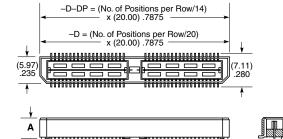
"X"R

-FR
= Full Reel
Tape & Reel
(must order
max. quantity
per reel;
contact Samtec
for quantity
breaks)
(N/A -05 to -07
lead style)

.030

QTE LEAD STYLE	A	HEIGHT WITH QSE*
-01	(4.27) .168	(5.00) .197
-02	(7.26) .286	(8.00) .315
-03	(10.27) .404	(11.00) .433
-04	(15.25) .600	(16.00) .630
-05	(18.26) .718	(19.00) .748
-07	(24.24) .954	(25.00) .984
-09	(13.26) .522	(14.00) .551

*Processing conditions will affect mated height. See SO Series for board space tolerances.



View complete specifications at: samtec.com?QTE

PROCESSING

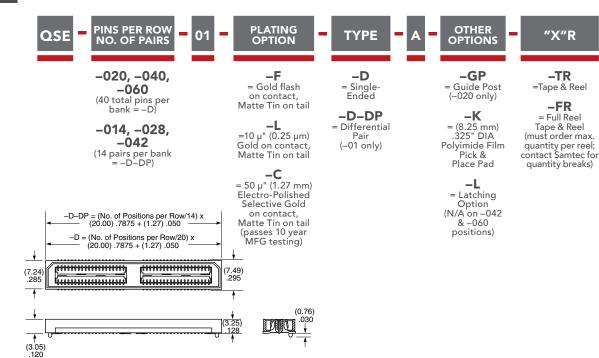
Lead-Free Solderable:

SMT Lead Coplanarity: (0.10 mm) .004" max (020-060)

Board Stacking:

For applications requiring more than two connectors contact ipg@samtec.com





Note:Some lengths, styles and options are non-standard, non-returnable.

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